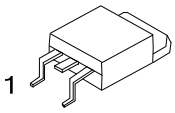
-100V, -16A P-CHANNEL POWER MOSFET



TO-252

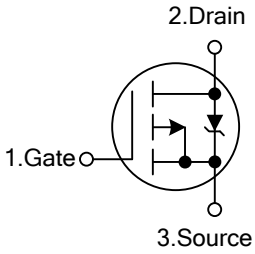
■ DESCRIPTION

The UTC **UTT16P10** is a P-channel power MOSFET using UTC's advanced technology to provide the customers with high switching speed, cost-effectiveness and a minimum on-state resistance. It can also withstand high energy in the avalanche.

■ FEATURES

* $R_{DS(ON)}$<0.21Ω @ V_{GS}=-10V, I_D=-16A
* High Switching Speed

■ SYMBOL



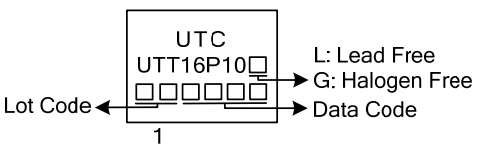
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UTT16P10L-TN3-R	UTT16P10G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

UTT16P10L-TN3-R (1)Packing Type (2)Package Type (3)Green Package	(1) R: Tape Reel (2) TN3: TO-252 (3) L: Lead Free, G: Halogen Free and Lead Free

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_J=25°C, unless otherwise specified)

PARAMETER			SYMBOL	RATINGS	UNIT
Drain-Source Voltage			V_{DSS}	-100	V
Gate-Source Voltage			V_{GSS}	±20	V
Drain Current	Continuous, V_{GSS}@-10V	T_C=25°C	I_D	-16	A
		T_C=100°C		-9.8	A
	Pulsed (Note 2)		I_{DM}	-64	A
Avalanche Current (Note 2)			I_{AR}	-16	A
Avalanche Energy	Repetitive (Note 3)		E_{AS}	345	mJ
	Single Pulsed (Note 2)		E_{AR}	15	mJ
Peak Diode Recovery dv/dt			dv/dt	-5.5	V/ns
Power Dissipation (T_C=25°C)			P_D	150	W
Junction Temperature			T_J	-55 ~ +150	°C
Storage Temperature			T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive rating; pulse width limited by max. junction temperature.
3. V_{DD}=-25V, starting T_J=25°C, L=2.7mH, R_G=25Ω, I_{AS}=-16A.

■ THERMAL DATA

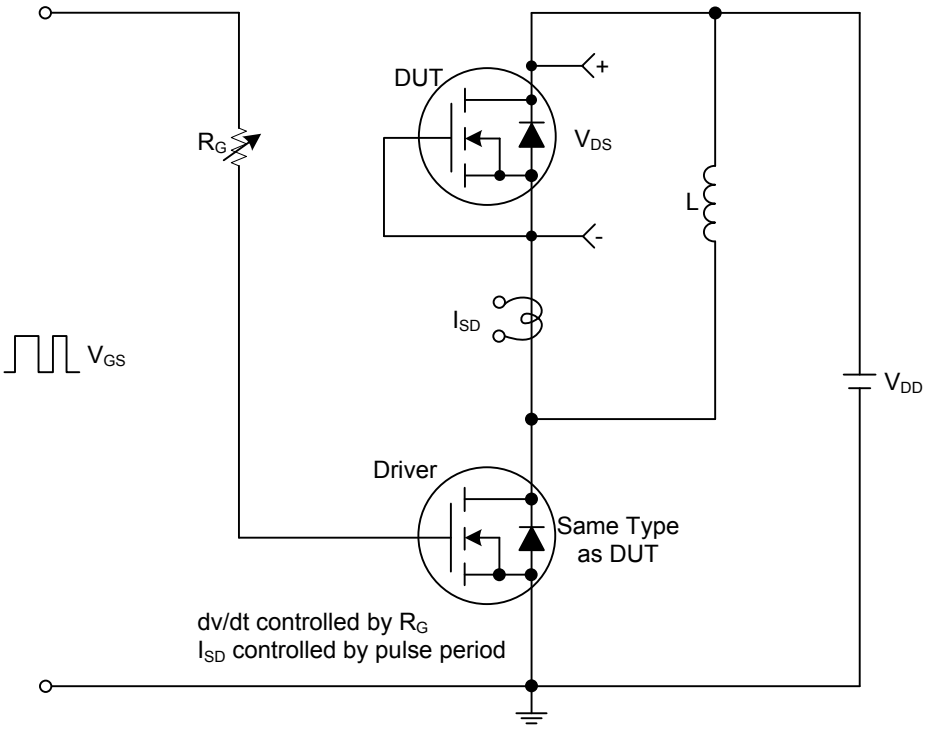
PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Case	θ_{JC}	1.0	°C/W

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

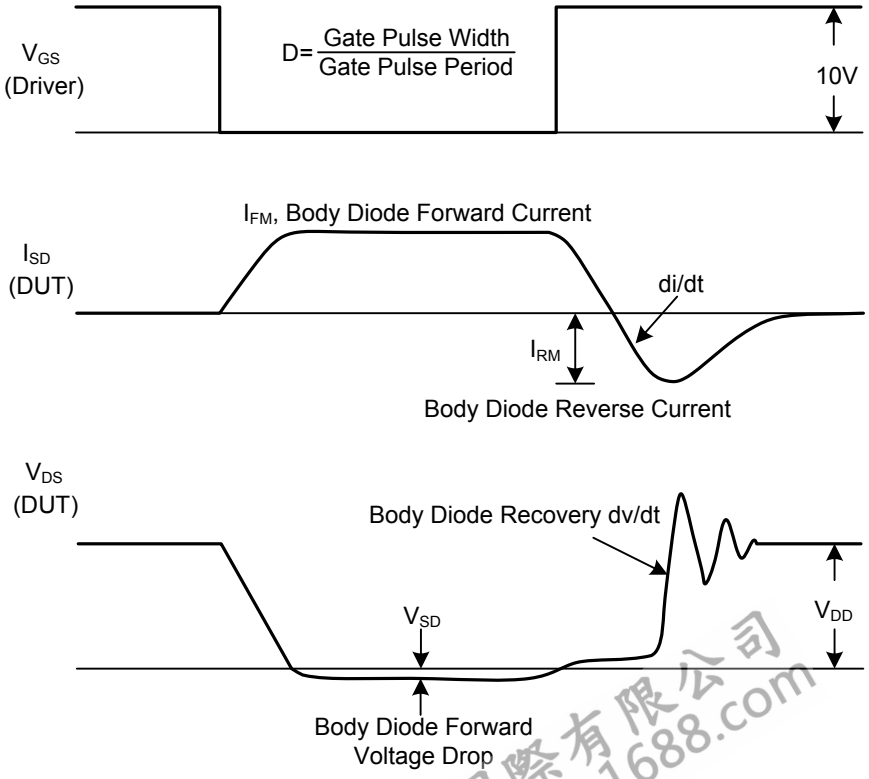
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	I_D=-250μA, V_{GS}=0V	-100			V
Breakdown Voltage Temperature Coefficient		$\Delta BV_{DSS}/\Delta T_J$	Reference to 25°C, I_D=-1mA		-0.1		V/°C
Drain-Source Leakage Current		I_{DSS}	V_{DS}=-100V, V_{GS}=0V,			-25	μA
			V_{DS}=-80V, V_{GS}=0V, T_J=150°C			-100	μA
Gate- Source Leakage Current	Forward	I_{GSS}	V_{GS}=+20V			+100	nA
	Reverse		V_{GS}=-20V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=-250μA	-1.0		-3.0	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS}=-10V, I_D=-16A (Note 2)			0.21	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS}	V_{DS}=-25V, V_{GS}=0V, f=1.0MHz		1180	1900	pF
Output Capacitance		C_{OSS}			250		pF
Reverse Transfer Capacitance		C_{RSS}			75		pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_G	V_{DS}=-80V, V_{GS}=-10V, I_D=-16A,		37	60	nC
Gate to Source Charge		Q_{GS}			5		nC
Gate to Drain ("Miller") Charge		Q_{GD}			15		nC
Turn-ON Delay Time		$t_{D(ON)}$	V_{DD}=-50V, I_D=-16A, R_G=9.1Ω, R_D = 2.4Ω		11		ns
Rise Time		t_R			25		ns
Turn-OFF Delay Time		$t_{D(OFF)}$			56		ns
Fall-Time		t_F			36		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_S	(Note 1)			-16	A
Maximum Body-Diode Pulsed Current		I_{SM}				-64	A
Drain-Source Diode Forward Voltage		V_{SD}	I_S=-16A, V_{GS}=0V (Note 2)			-1.3	V

Notes: 1. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %.
2. Repetitive rating; pulse width limited by max. junction temperature.

■ TEST CIRCUITS AND WAVEFORMS



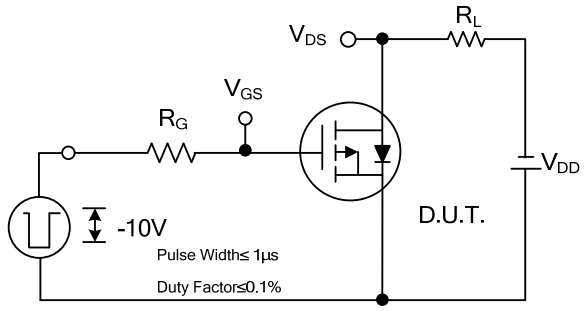
Peak Diode Recovery dv/dt Test Circuit



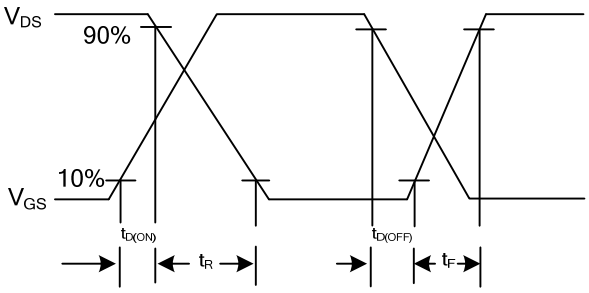
Peak Diode Recovery dv/dt Test Circuit and Waveforms

Peak Diode Recovery dv/dt Waveforms

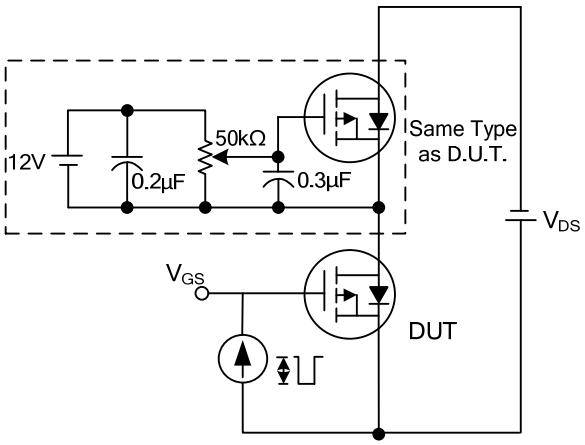
■ TEST CIRCUITS AND WAVEFORMS



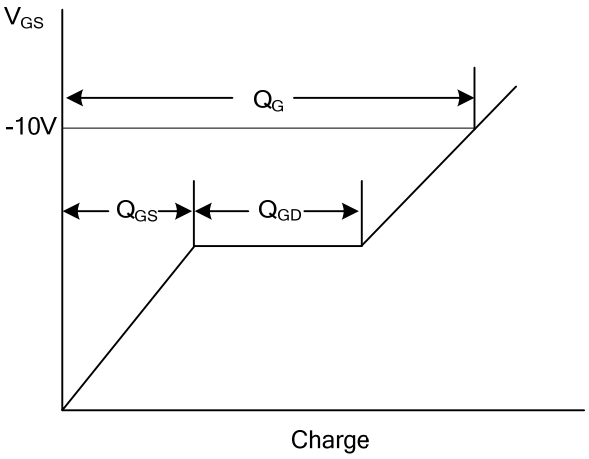
Switching Test Circuit



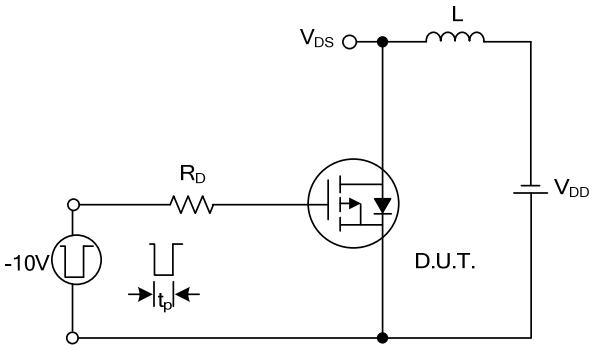
Switching Waveforms



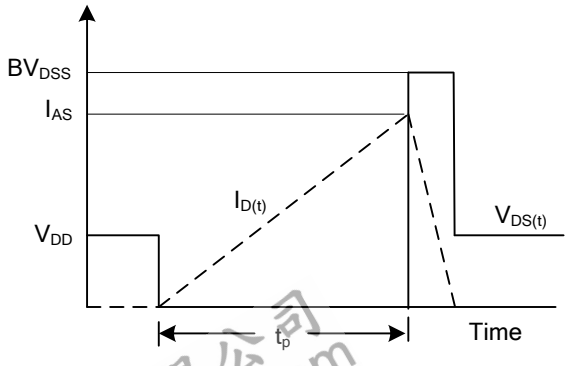
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms